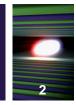


Recent Hardware and Software Achievements for the European XFEL

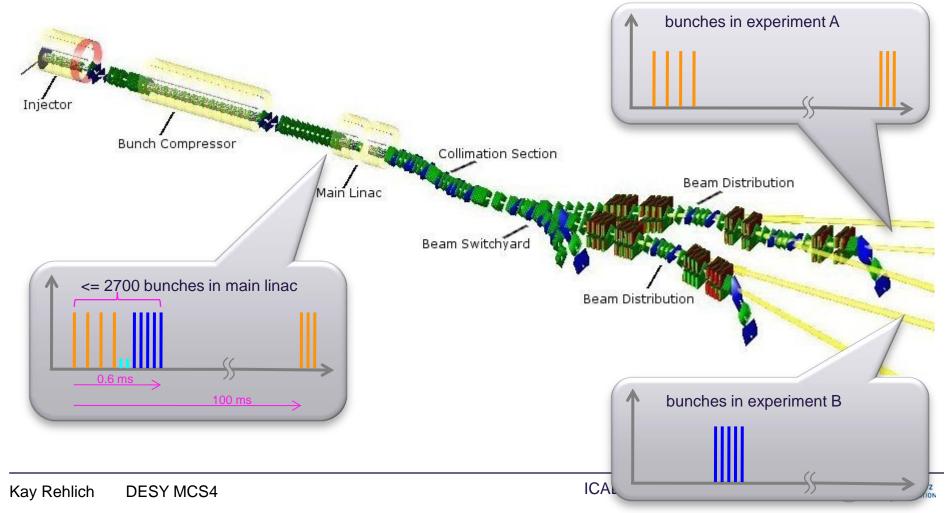
Kay Rehlich On behalf of the FLASH / XFEL Controls Group







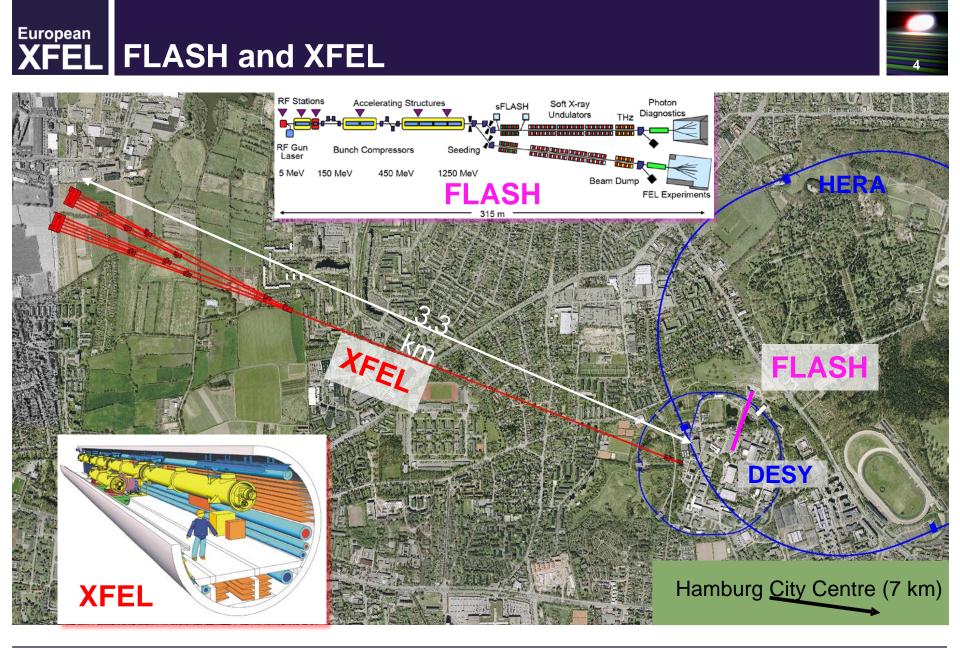
- The XFEL can produce 27 000 bunches per second
- Synchronization of all sub-systems is a challenge



XFEL Outline

- Synchronization of sub-systems
- Hardware implementation
 - Timing system in µTCA
- Software implementation
 - OMQ Inter Process Communication
 - DAQ system
- Conclusions



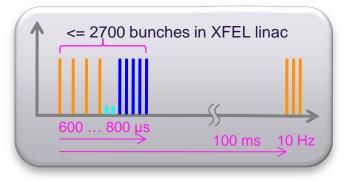


Recent Hardware and Software Achievements for the European XFEL



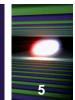
XFEL Synchronization of Sub-Systems

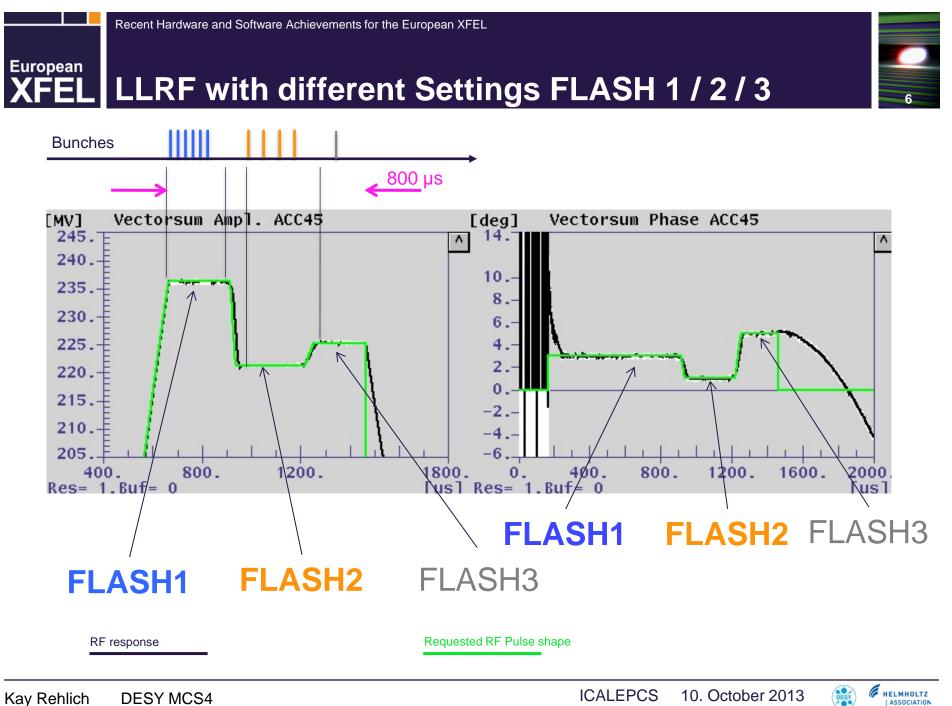
- Variable bunch pattern for the users
- Can change with 10 Hz (shot to shot)
- Sub-Systems require the pattern before bunch trains arrive



- The timing system distributes the information to
 - Different lasers to generate the desired charges
 - LLRF to set the gradients and phases
 - Loss detection to check the bunches
 - Software to display and archive, learning algorithms, calc.
 means, etc.
- Transport via dedicated fiber links and MicroTCA backplane







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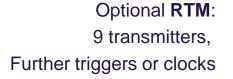


European **XFEL** New MicroTCA Timing Module

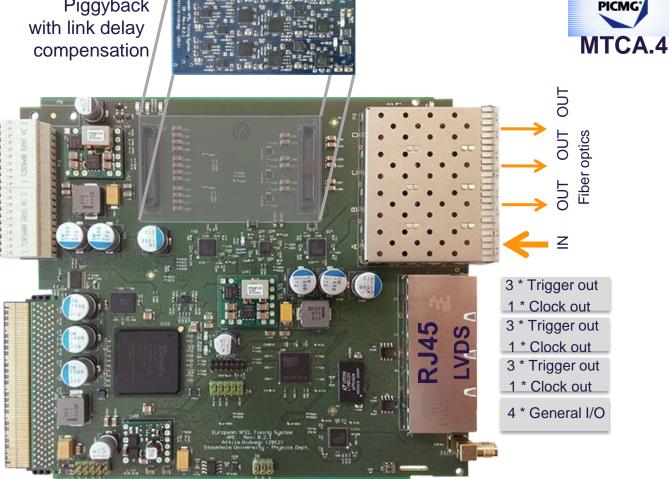
Can be used as a timing receiver or transmitter

Piggyback with link delay

Transmitter



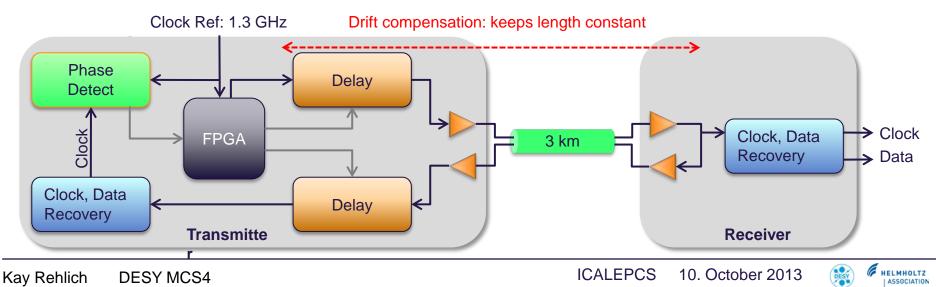
MicroTCA **backplane**: TCLKA and TCLKB, 8 * M-LVDS





XFEL XFEL Timing System

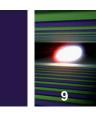
- Fiber optic links @ 1.3GHz
- AMC module is a receiver:
 - It retransmits on one link
 - Or transmits on 3 fiber links with drift compensation (piggyback)
- ps stability (5 …10 ps RMS)
- Clock, trigger and event distribution
- Distribution of data words and tables









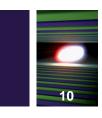


XFEL Timing System: Real Time Configuration Data

Main Operating Table	Editor Expert		Main Timing Cont
Main Operating Table	Editor Expert	12 	
Order of Bunches	in Beam Lines:	FLASH 1 - FLASH 2	
FLASH	1	FLASH 2	FLASH 3
Enable: 🔽	1	Enable: 🔽	
Number of Bunches:	22	Number of Bunches: ຼີງີອີ	
Repition Rate:	MHz 💌	Repition Rate: 100 kHz	
Charge Range:	.1.1nC 💌	Charge Range: 0 0.1 nC 💌	
Laser: 1	•	Laser: 2	
1. Bunch Position:	200 µs	1. Bunch Position: 2280 µs	
Last Bunch Position:	230 #	Last Bunch Position: ၂၄၇၇ မှန	
	_		
600 7	00	800 900 1000	1100 12



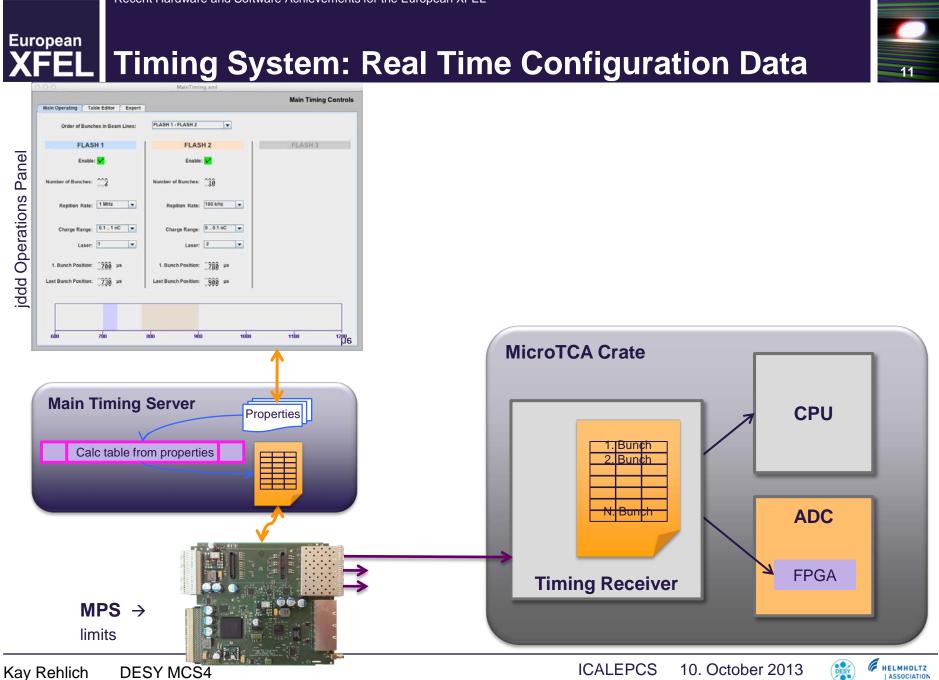




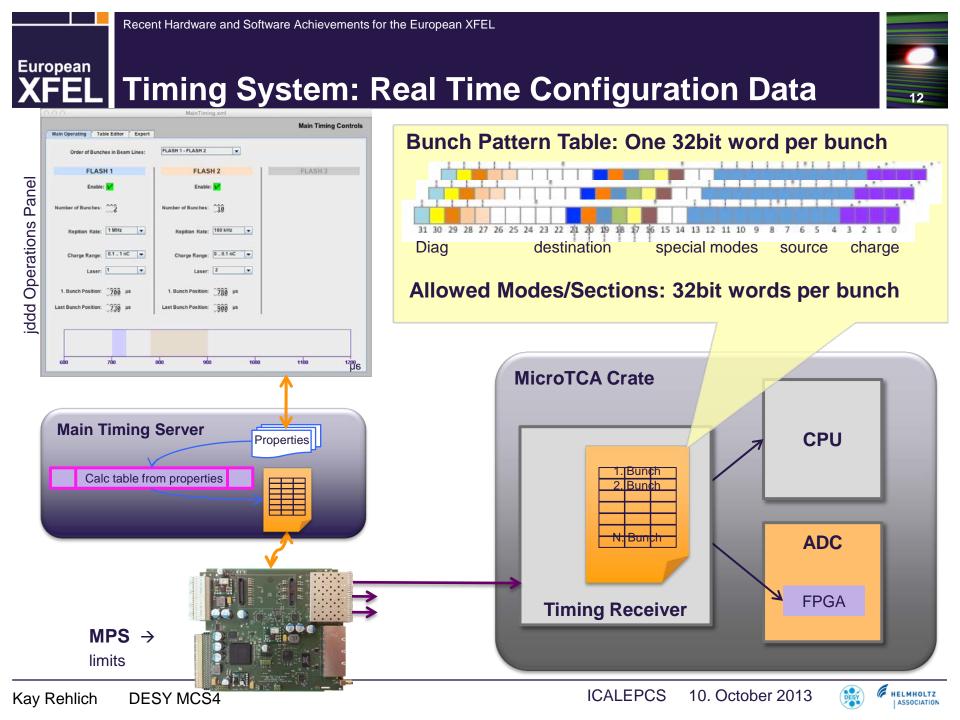
XFEL Timing System: Real Time Configuration Data

Main Operating Table Editor E	xpert	Main Timing Controls
Order of Bunches in Beam Lin	es: PLASH 1 - PLASH 2	
FLASH 1	FLASH 2	FLASH 3
Enable:	Enable: 💅	
Enable: V Number of Bunches: Repition Rate: 1 MHz Charge Range: 0.1_1nC Laser: 1 1. Bunch Position: 238 µs Last Bunch Position: 238 µs	Number of Bunches:	
Repition Rate: 1 MHz	Repition Rate: 100 kHz	
Charge Range: 0.1 - 1 nC	Charge Range: 00.1 nC	
Laser: 1	Laser: 2	
1. Bunch Position: 200 µs	1. Bunch Position: 2280 µs	
Last Bunch Position: (23) µs	Last Bunch Position: ូម្ភិត្តិត្តិ μន	
600 700	800 900 1000	1100 1200 UG
Main Timin	g Server	operties
	from properties	operties]
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	from properties	operties



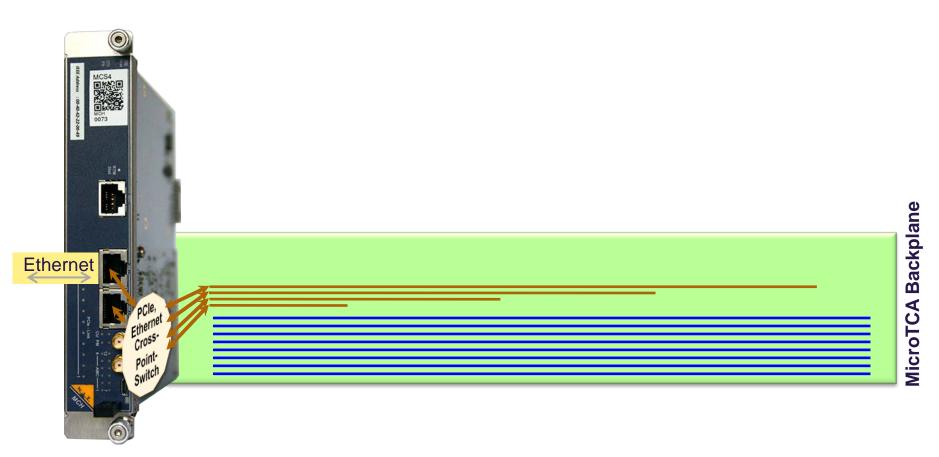


Recent Hardware and Software Achievements for the European XFEL





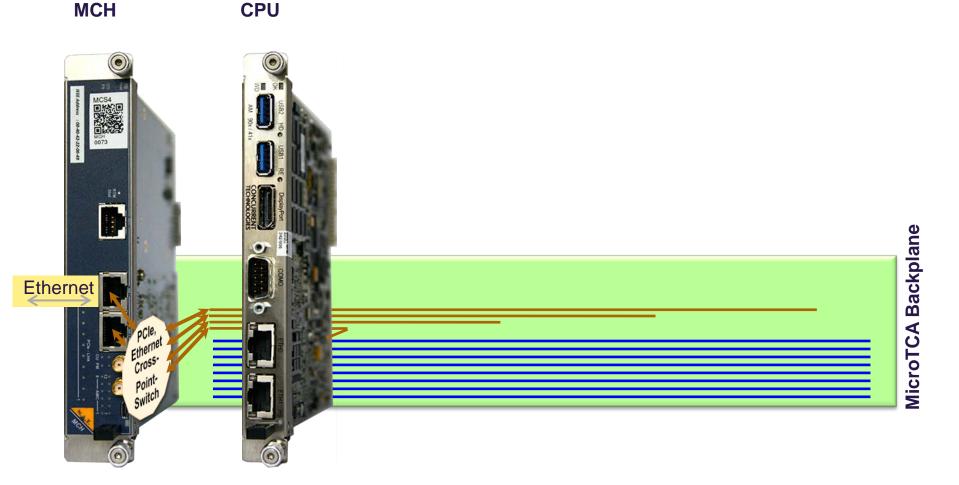
MCH





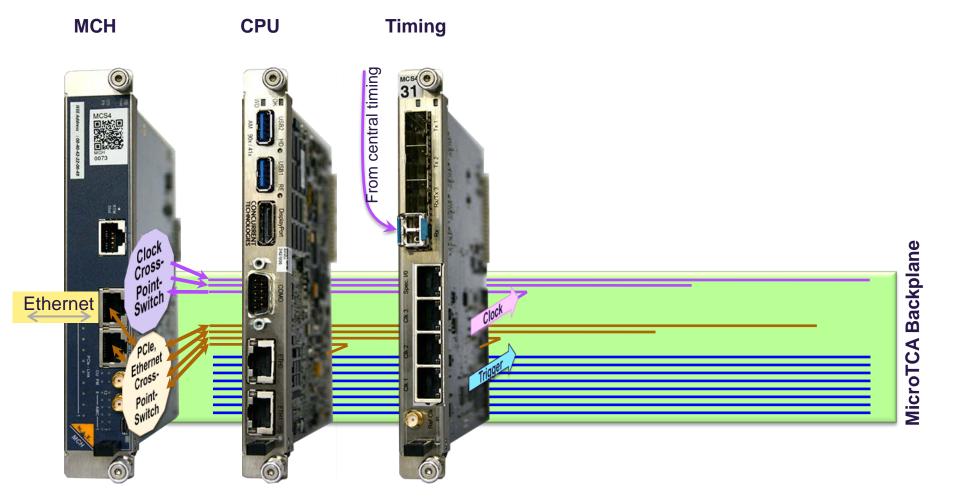


XFEL MicroTCA.4: Clock and Trigger Distribution





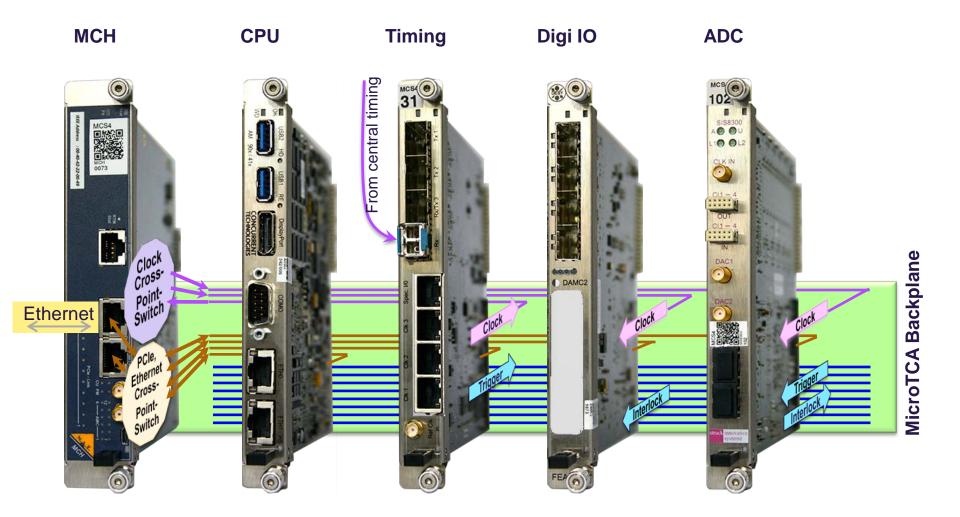








European **XFEL** MicroTCA.4: Clock and Trigger Distribution





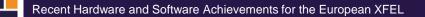




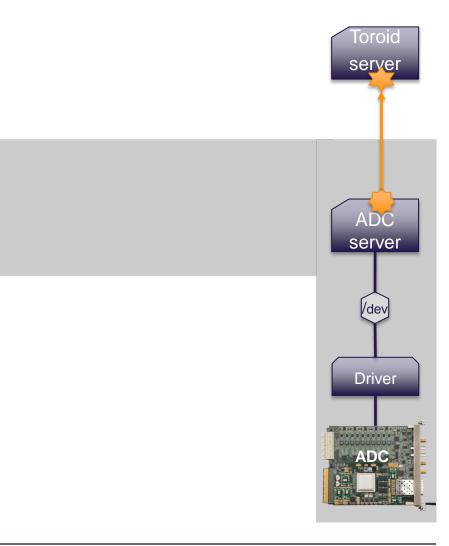
XFEL ZeroMQ Messaging Integration





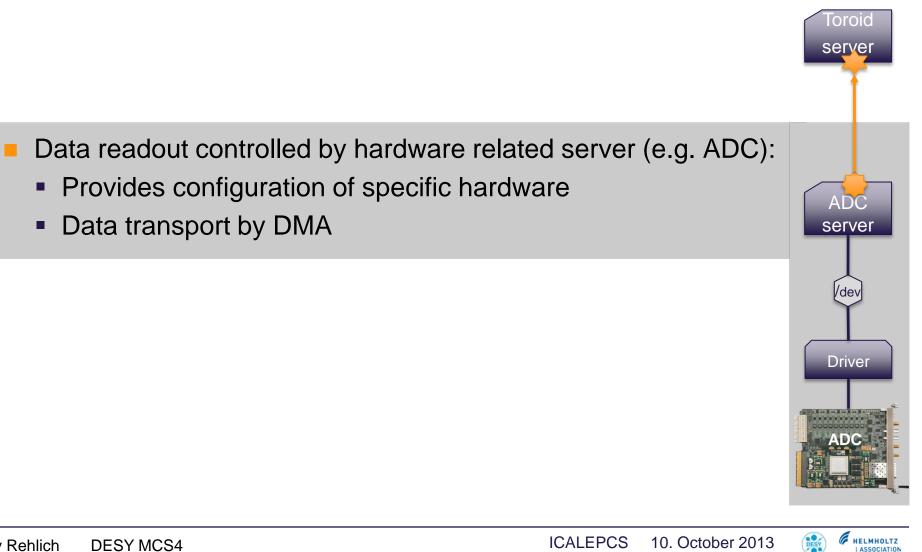


XFEL ZeroMQ Messaging Integration





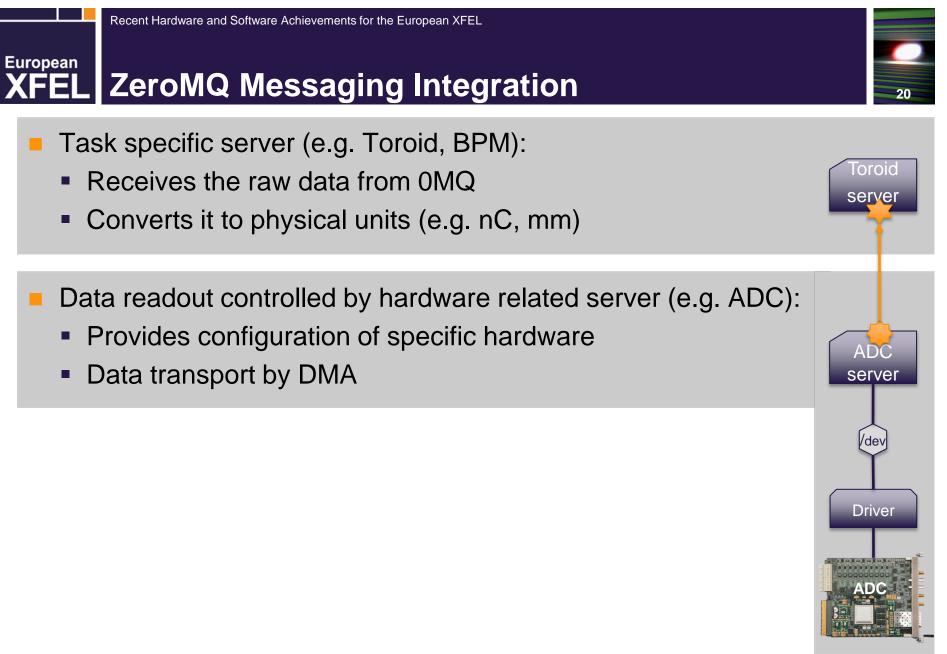




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European FEL ZeroMQ Messaging Integration

- Task specific server (e.g. Toroid, BPM):
 - Receives the raw data from 0MQ
 - Converts it to physical units (e.g. nC, mm)

Data readout controlled by hardware related server (e.g. ADC):

- Provides configuration of specific hardware
- Data transport by DMA
- DOOCS front-end servers implement **OMQ** Library:
 - To decouple processes
 - To avoid semaphores between processes
 - To dynamically attach / detach processes to data
 - To receive shot related info from timing
 - \rightarrow learning algorithms



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oroid

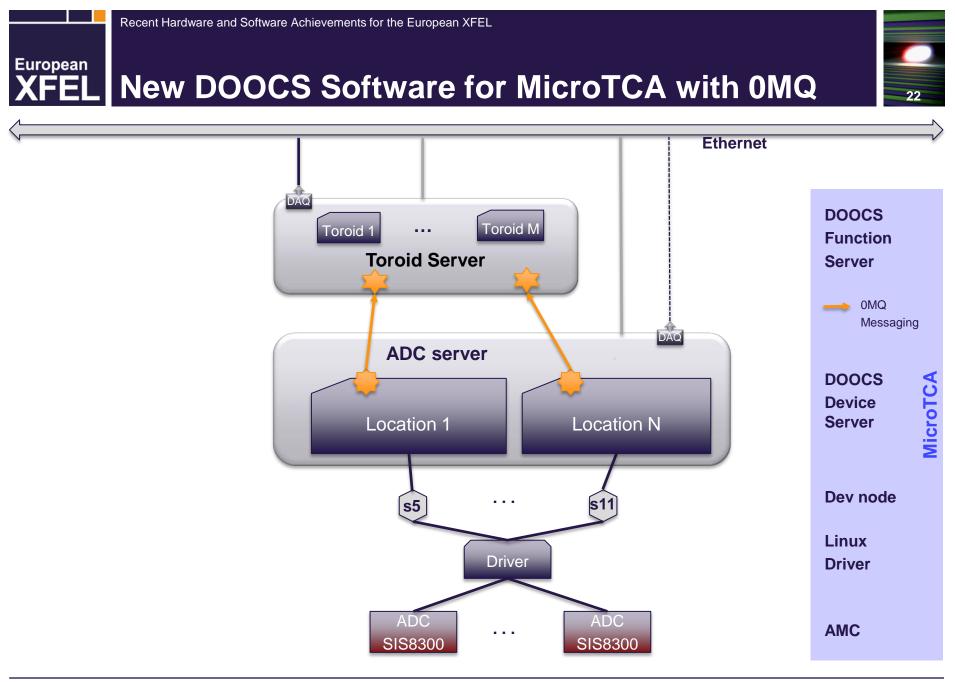
server

ADC

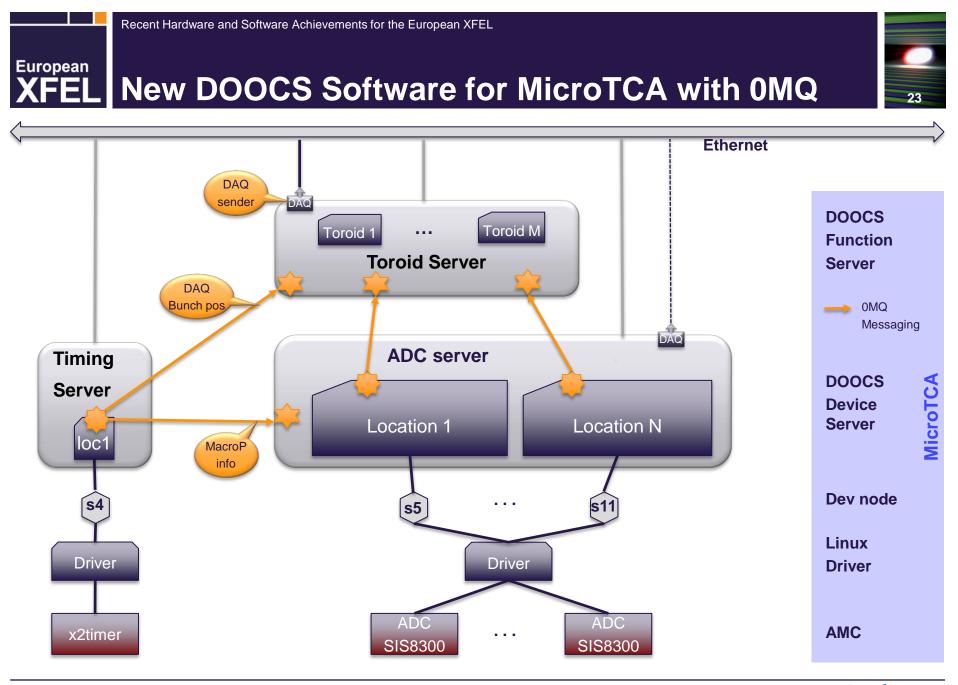
server

/de\

Driver



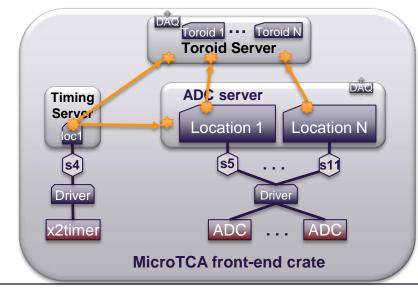








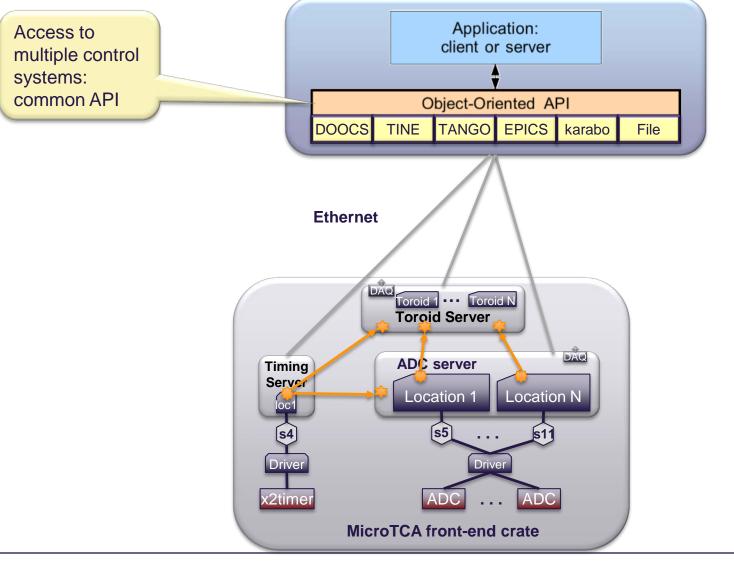




Kay Rehlich DESY MCS4

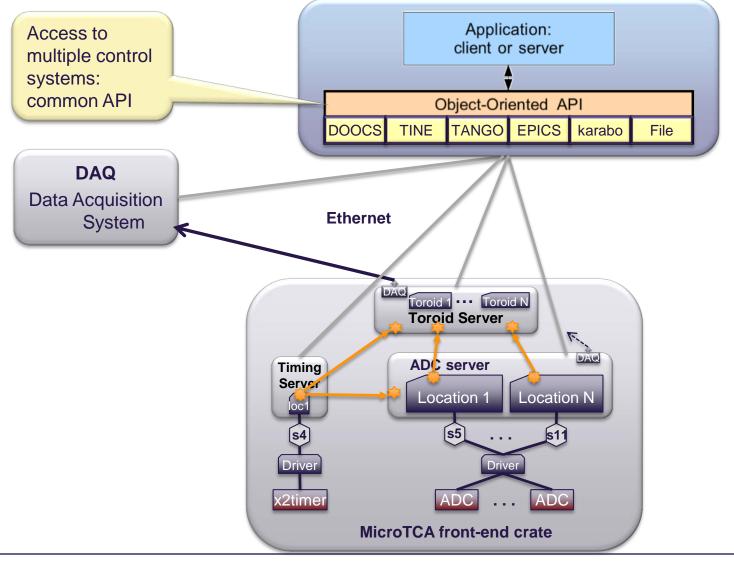


XFEL System Integration





XFEL System Integration





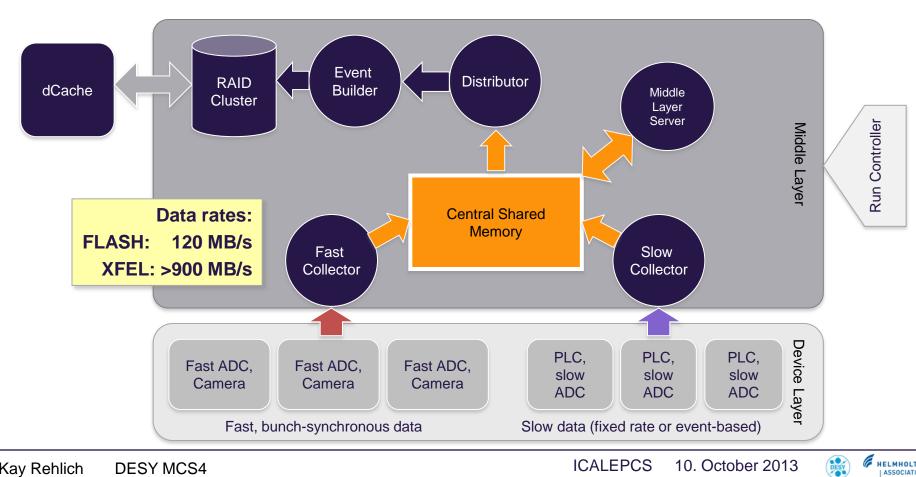


XFEL The Data Acquisition System (DAQ)







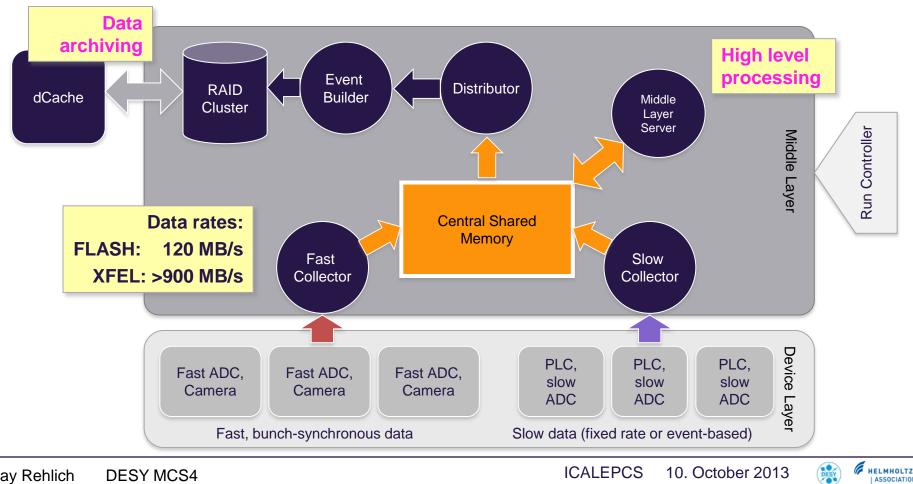


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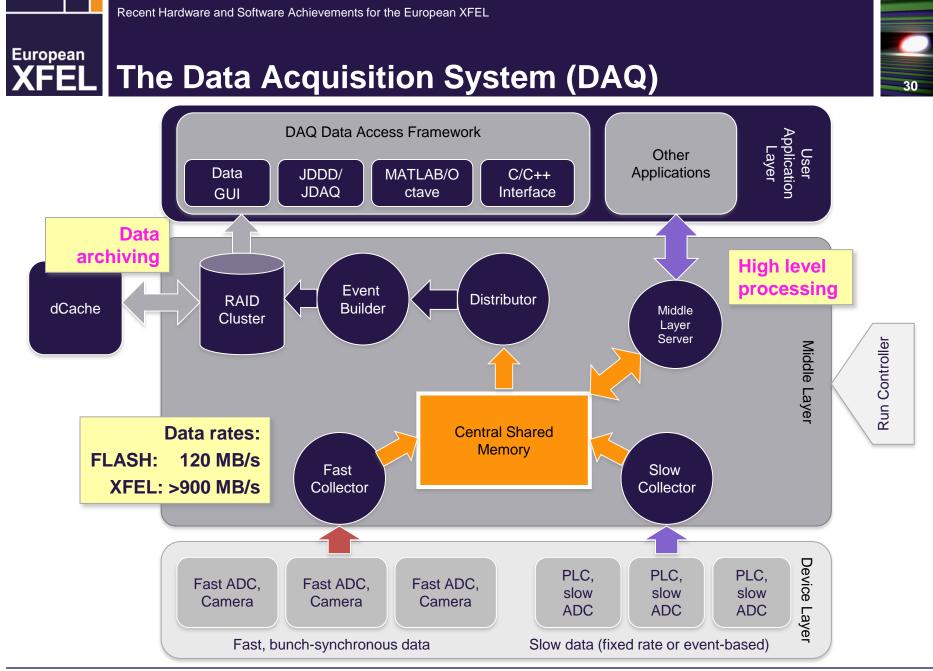




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Panel created by jddd



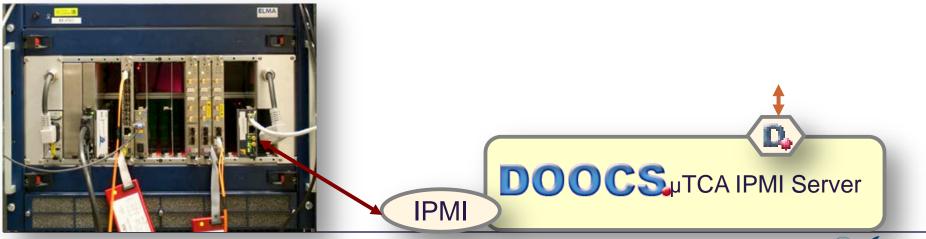
Kay Rehlich DESY MCS4







Panel created by jddd

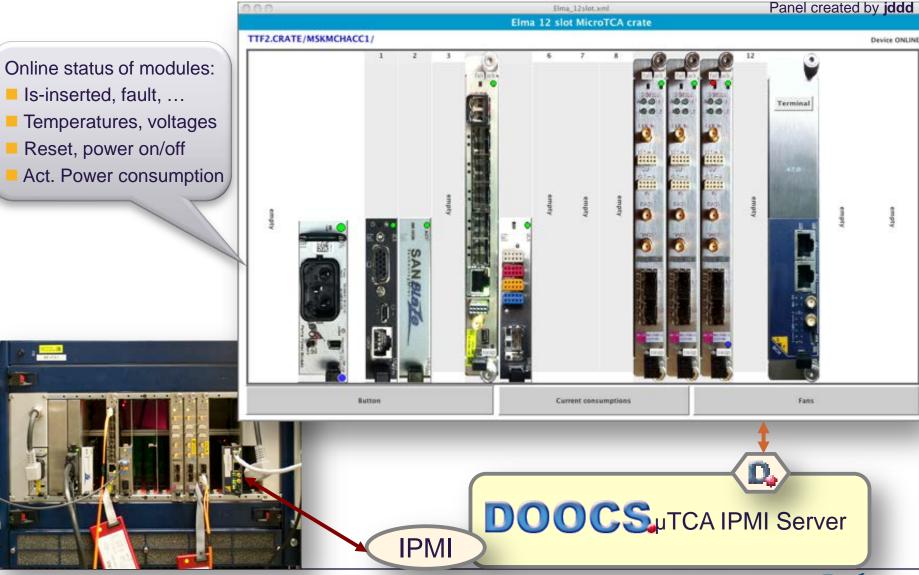


Kay Rehlich DESY MCS4

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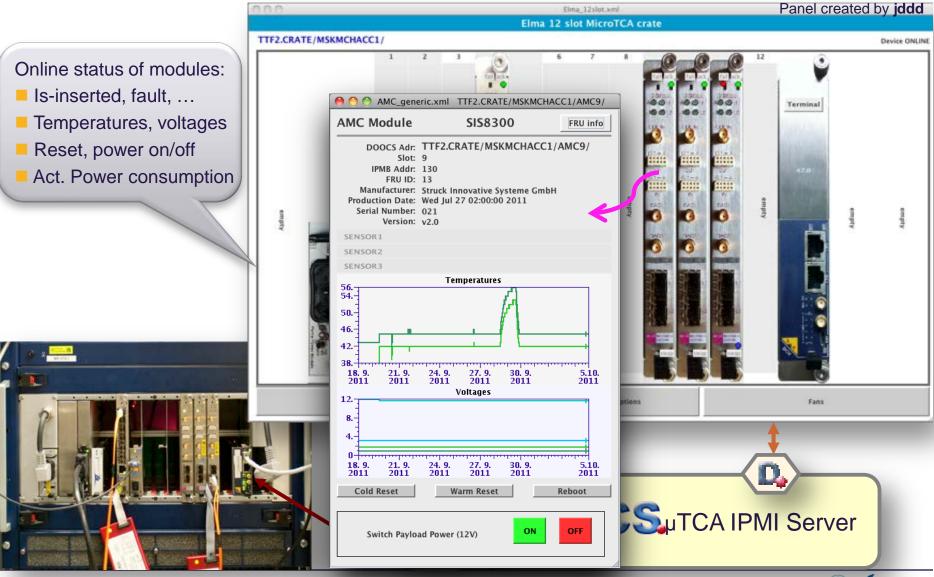




Kay Rehlich DESY MCS4

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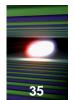
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Kay Rehlich DESY MCS4

EuropeanXFELMicroTCA Crate Overview

	00	cra	ate_select.xml	Panel created by jddd		
	MicroTCA Crates					
	GROUP_CAMERA : MINMCHKICKER1		MCSMCH0: Off	Labs		
Shows all Crates Ordered by Name	MINMCHKICKER2 : show ELMA Trenew Electronic G 5 MINMCHKICKER3 : off MINLIHUB4 : off		MCSMCH9 : shi MCSMCHTIME1 : shi	ow Schroff GmbH 6 ow Schroff GmbH 6 ow ELMA Trenew Electronic G 6		
	FLASHMCHKLY39 MSKMCHACC1 : FLAMCHEOSTHZ :	ELMA Trenew Electronic G 5 Show ELMA Electronic GmbH 12		ow ELMA Trenew Electronic G 5 ow Schroff GmbH 6		
	FLASHMCHTIME1 FLASHMCHG49 : FLASHMCHMPS1 :	: show ELMA Trenew Electronic G 12	MSKMCHTDS1 : sh MSKMCH2 : sh	ow ELMA Electronic GmbH 6 ow ELMA Electronic GmbH 12 ow ELMA Electronic GmbH 12		
			TTFPREP : off	ow ELMA Electronic GmbH 12 ow Schroff GmbH 12		
	Modules in sele	ected crate: TTF2.CRATE/MSKMC	CHACC1/	show graphical		
Shows all Modules in Selected Crate		ELMA Electron IPMB:0xc4 Sensor N:51 Type:FRU Hot unkown module	t Swap Event:Transition to M3	info		
	AMC8 :	SIS8300 Struck Innovative Systeme GmbH U=	1.8 Temp= 41.0			
	AMC4 : AMC10 :		2.5 Temp= 44.0 1.8 Temp= 44.0			
	AMC12: AMC1:		1.8 Temp= 47.0 12.2 Temp= 56.0			
	AMC2 : AMC5 :		12.0 Temp= 30.0 12.3 Temp= 33.0			
			emp= 0.0 0.0 emp= 0.0 0.0	info OO info OO		
	MCH : POWER_UNIT1 :		emp= 43.0 43.0 30.0 30.0 Temp= 4	info O 45.0 55.0 info O		



XFEL Conclusions



- Successful system tests with key MicroTCA modules based on MTCA.4 standard @ FLASH
- MicroTCA integration in DOOCS:
 - New 0MQ inter process communication
 - Hot-swap, Linux driver with DMA, device server, management
- Synchronized data processing implemented:
 - On timing and ADC and controls hardware
 - On device servers, including ZeroMQ
 - On middle layer data processing and storage
 - On client applications (e.g. jddd)



XFEL XFEL & FLASH Contributions @ ICALEPCS2013



- Sven Karstensen TUCOCA01 XFEL Machine Protection System (MPS) Based on uTCA
- Elke Sombrowski TUPPC104 jddd: A Tool for Operators and Experts to Design Control System Panels
- Raimund Kammering THPPC121 Feedbacks and Automation at the Free Electron Laser in Hamburg (FLASH)
- Kay Rehlich THPPC093 The New Timing System for the European XFEL
- Wojciech Cichalewski THPPC135 From Pulse to Continuous Wave Operation of TESLA Cryomodules LLRF System
- Jaroslaw Szewinski THPPC140 uTCA Upgrade of the Readout Electronics for the Bunch Arrival Time Monitor a
- Christian Schmidt THPPC122 High Performance and Low Latency Single Cavity RF Control Based on MTCA.
- Thomas Walter MOPPC081 The Case of MTCA.4: Managing the Introduction of a New Modular Electronic C
- Holger Schlarb FRCOBAB02 Ultra-fast Longitudinal Feedbacks for the European XFEL
- Lukasz Butkowski TUCOCA09 Klystron Measurement and Protection System for XFEL on the uTCA Architectular
- Tomasz Jezynski THPPC094 Managed Precision Clock and RF Signal Distribution over Custom RF-backplar
- Julien Branlard THPPC072 Superconducting Cavity Quench Detection and Prevention for the European XF
- Burkhard Heisen FRCOAAB02 Karabo: An Integrated Software Framework Combining Control, Data Managen
- Nicola Coppola TUPPC046 Control Using Beckhoff Distributed Rail Systems at the European XFEL

